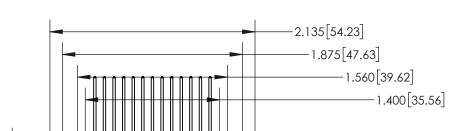
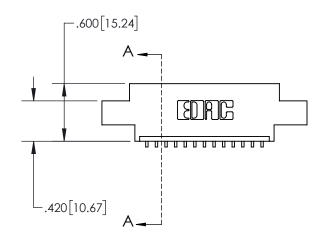
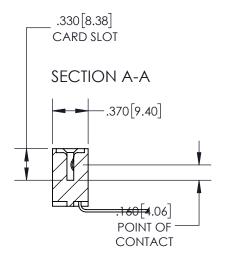
## **Contact Dimensions:** 559-90 Degree Bend (Code 541 Contacts) See Sheet 2 for Contact Code 555, 556, 558, 559, 560 Dimensions

-2x Ø.128[3.25]



CARD SLOT ACCEPTS -.054" [1.37] TO .070"[1.78] THICK PCB





- INSULATOR MATERIAL: THERMOPLASTIC, UL 94V-0
- CONTACT MATERIAL; COPPER TIN ALLOY
  CONTACT PLATING: GOLD ON THE MATING AREA, TIN PLATING
  ON THE CONTACT TAILS, NICKEL UNDERPLATE

845/895	SERIES HIGH TEM	IP CARD	EDGE	CONNEC	TOR
PART NI	JMBFR: 845-013-5	559-602			

YOUR CONNECTION TO QUALITY & SERVICE

ACAD REFERENCE N	0. 845-ENG-MASTER
DRAWN: R.STA.MONICA	DATE:MAY.16/2017
CHECKED:	DATE:
SCALE: 1:1	SHEET 1 OF 2
DRAWING NUMBER	ISSUE

845-ENG-MASTER







INSULATOR MATERIAL: THERMOPLASTIC POLYESTER, UL 94V-0 DAP MATERIAL AVAILABLE UPON REQUEST

CONTACT MATERIAL; COPPER ALLOY CONTACT PLATING: GOLD ON THE MATING AREA, TIN PLATING ON THE CONTACT TAILS, NICKEL UNDERPLATE

## 845/895 SERIES HIGH TEMP CARD EDGE CONNECTOR CONTACT CODE 555,556,558,559,560 DIMENSIONS

YOUR CONNECTION TO QUALITY & SERVICE

	ACAD REFERENCE NO. 845-ENG-MASTER				
	DRAWN: R.STA.MONICA	DATE: <b>MAY.16/2017</b>			
	CHECKED:	DATE:			
)	SCALE: 1:1	SHEET 2 OF 2			
ED	DRAWING NUMBER	ISSUE			

845-ENG-MASTER